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FIRST NAMED INVENTOR ATTORNEY DOCKET NO. **FILING DATE** APPLICATION NO. R 3656US(95-00 LANGLEY 09/438,692 11/11/99 **EXAMINER** MM91/1017 JOSEPH A WALKOWSKI ART UNIT PAPER NUMBER TRASK BRITT & ROSSA P O BOX 2550 2822 SALT LAKE CITY UT 84110

DATE MAILED:

10/17/01

Please find below and/or attached an Office communication concerning this application or proceeding.

Commissioner of Patents and Trademarks

	Application N	o.	Applicant(s)		
Office Action Summary			LANGLEY, RODNEY C.		
	09/438,692 Examiner		Art Unit		
	Roy K Potter		2822		
The MAILING DATE of this communication ap		er sheet with the c			
Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b). Status					
1) Responsive to communication(s) filed on					
2a) ☐ This action is FINAL. 2b) ☑ TI	is action is FINAL. 2b)⊠ This action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims					
4)⊠ Claim(s) <u>1-29</u> is/are pending in the application.					
4a) Of the above claim(s) is/are withdrawn from consideration.					
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>1-29</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers					
9) The specification is objected to by the Examiner.					
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
11) The proposed drawing correction filed on is: a) approved b) disapproved by the Examiner.					
If approved, corrected drawings are required in reply to this Office action.					
12) The oath or declaration is objected to by the Examiner.					
Priority under 35 U.S.C. §§ 119 and 120 13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a) All b) Some * c) None of:					
1. Certified copies of the priority documents have been received.					
2. Certified copies of the priority documents have been received in Application No					
3. Copies of the certified copies of the priority documents have been received in this National Stage					
application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.					
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).					
 a) The translation of the foreign language provisional application has been received. 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 					
Attachment(s)					
 Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 	· -	Notice of Informal F	(PTO-413) Paper No(s)	,	

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DETAILED ACTION

Reissue Applications

Claims 1 - 29 are rejected under 35 U.S.C. 251 as being an improper recapture of broadened claimed subject matter surrendered in the application for the patent upon which the present reissue is based. See *Hester Industries, Inc.* v. *Stein, Inc.*, 142 F.3d 1472, 46

USPQ2d 1641 (Fed. Cir. 1998); *In re Clement,* 131 F.3d 1464, 45 USPQ2d 1161 (Fed. Cir. 1997); *Ball Corp.* v. *United States,* 729 F.2d 1429, 1436, 221 USPQ 289, 295 (Fed. Cir. 1984).

A broadening aspect is present in the reissue which was not present in the application for patent.

The record of the application for the patent shows that the broadening aspect (in the reissue) relates to subject matter that applicant previously surrendered during the prosecution of the application. Accordingly, the narrow scope of the claims in the patent was not an error within the meaning of 35 U.S.C. 251, and the broader scope surrendered in the application for the patent cannot be recaptured by the filing of the present reissue application.

Applicant is attempting to rapture claimed subject matter that relates to the openings in the bond pads extending through the bond pads rather than just to the bond pads. During the prosecution of the original application, Applicant amended the claims in the original application to recite that the opening extended partially into the bonding surface or pads, deliberately surrendering the subject matter of openings that extend through the surface or pads.

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Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless --

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1 - 2, 7, 8, 13, 15 - 18, 23 - 27 are rejected under 35 U.S.C. 102(b) as being anticipated by Kishi.

Kishi, discloses a semiconductor integrated circuit device which includes through-holes in the bonding pad. As shown in figures 1a and 1b, an aluminum pad electrode 4 has through holes in the bonding pad. As shown in Figures 1a, and 1b, an aluminum pad electrode 4 has holes 7 in it which help absorb bonding stress. As shown in the cross sectional Figure, Figure 16, aluminum pad electrode 4 has a flat upper surface. Passivation layer 8 is located on top of the wiring layer 6 and has an opening corresponding to the location of the electrode pad 4. Active circuits in the substrate comprise diffusion areas 2 to which bond pad electrode 4 is connected through the wiring layer 6.

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Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Roy Potter whose telephone number is (703) 308 - 4106.

Roy Potter

Primary Examiner

Technology Center 2800

Potter October 16, 2001